ATTY DKT. No.: U.S. SERIAL No.:

FILED:

CONF. No.: UNKNOWN

APPLICANT: TITLE:

AMAT/7164.C1/CMP/ECP/RKK
UNKNOWN CONF. NO.: UNKNOWN
HEREWITH
APPLIED MATERIALS, INC.
MODULAR ELECTROCHEMICAL PROCESSING SYSTEM

INVENTOR: CHEN, ET AL.
EXPRESS MAIL NO.: EV351031985US

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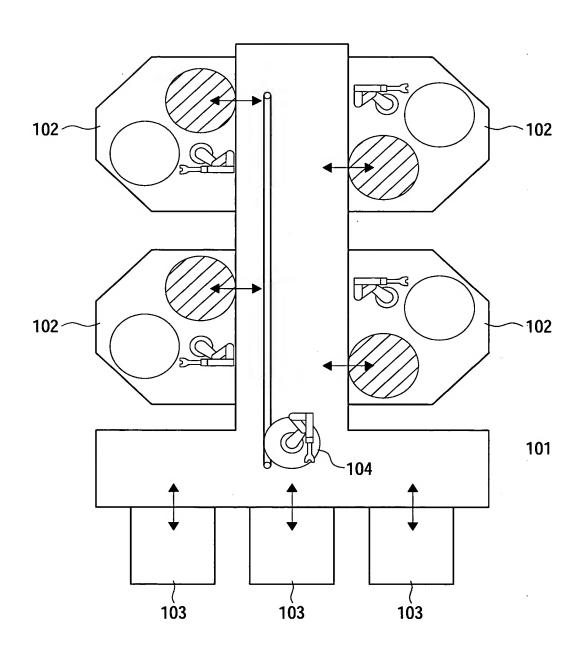


FIG. 1

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ATTY DKT. NO.:

U.S. SERIAL NO.:
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HEREWITH

APPLICANT:
TITLE:
MODULAR ELECTROCHEMICAL PROCESSING SYSTEM
EXPRESS MAIL NO.:
EXPRESS MAIL NO.:

AMAT/7164.C1/CMP/ECP/RKK
UNKNOW
HEREWITH
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CHEN, ET AL.
EXPRESS MAIL NO.:

EV351031985US

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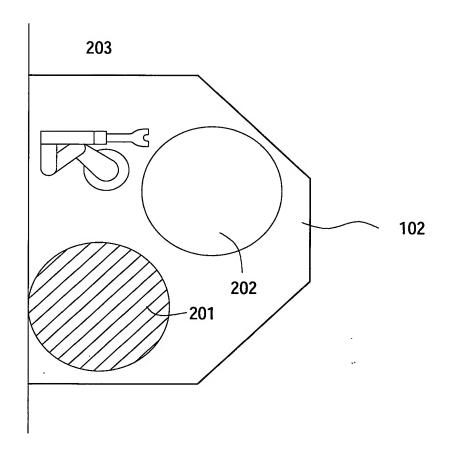


FIG. 2

ATTY DKT. NO.: U.S. SERIAL NO.:

ATTY DKT. NO.:

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FILED:
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APPLICANT:
TITLE:
INVENTOR:
EXPRESS MAIL NO.:

AMAT/7164.C1/CMP/ECP/RKK

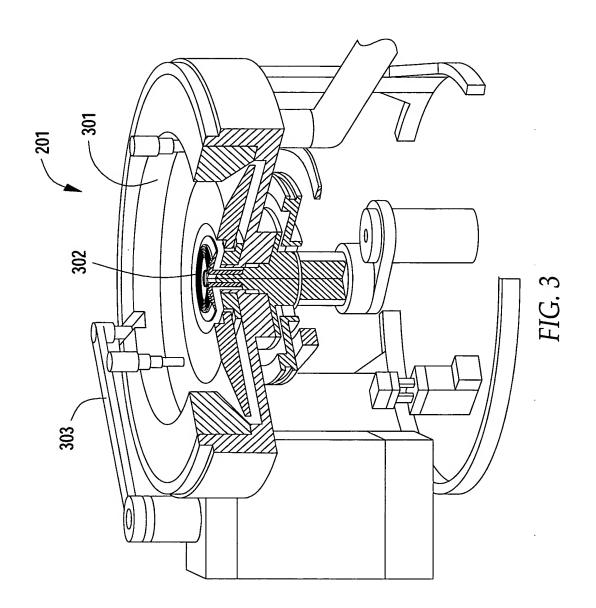
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MODULAR ELECTROCHEMICAL PROCESSING SYSTEM
CHEN, ET AL.
EV351031985US

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PAGE 3 of 4

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APPLIED MATERIALS, INC.
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